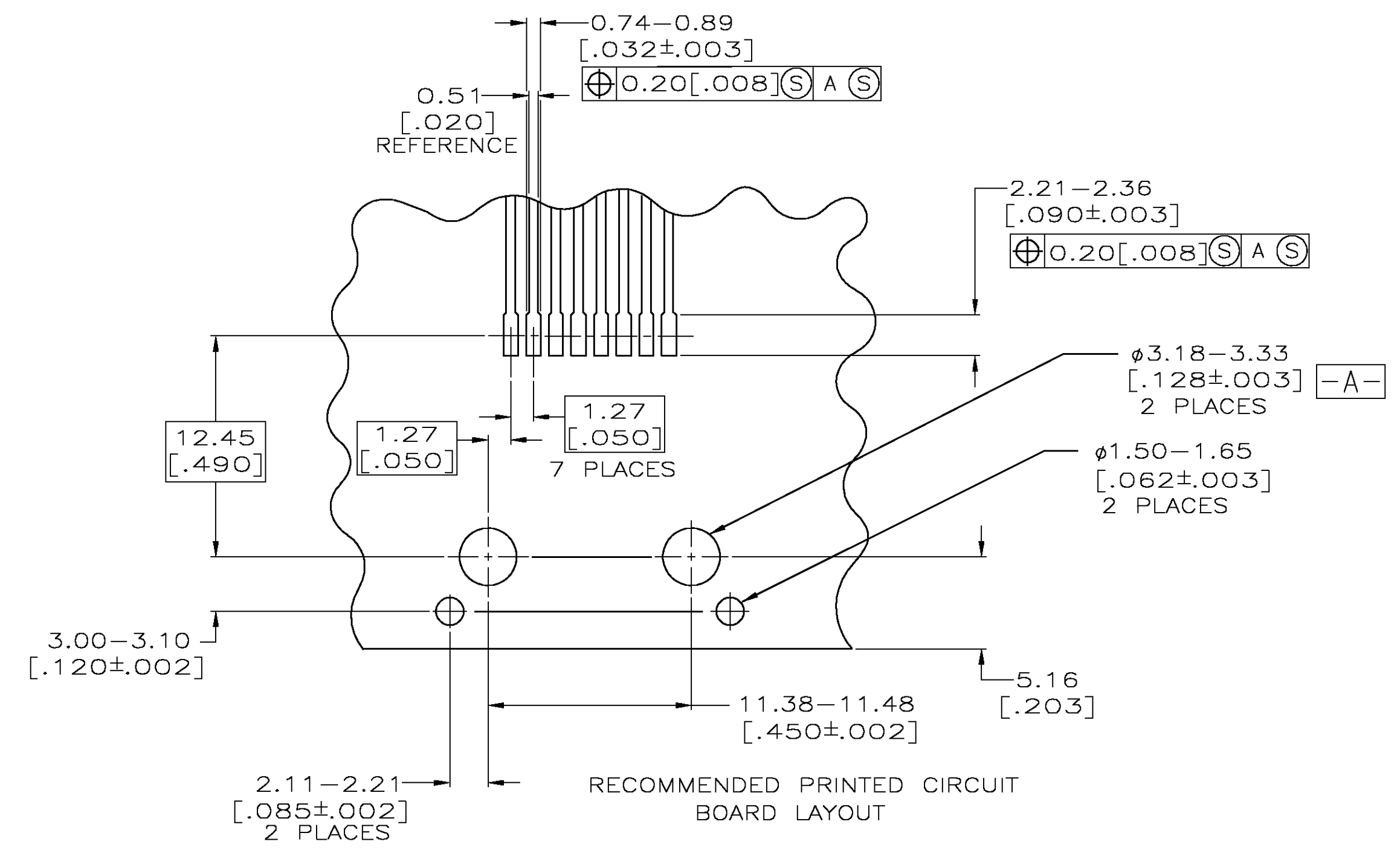
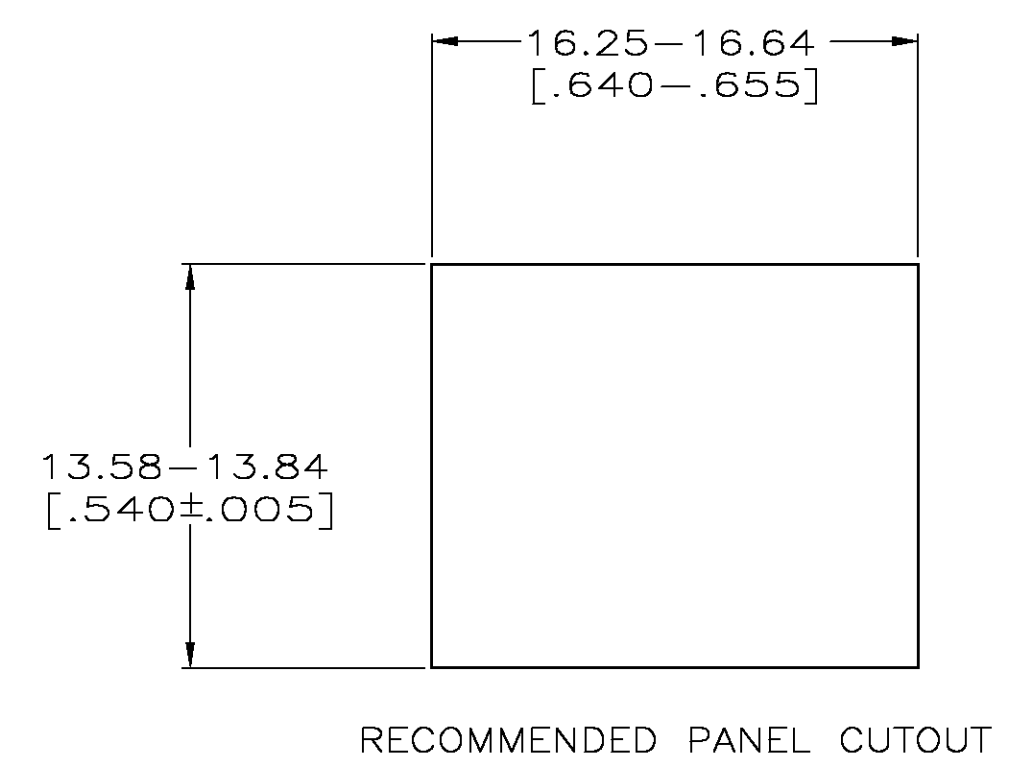
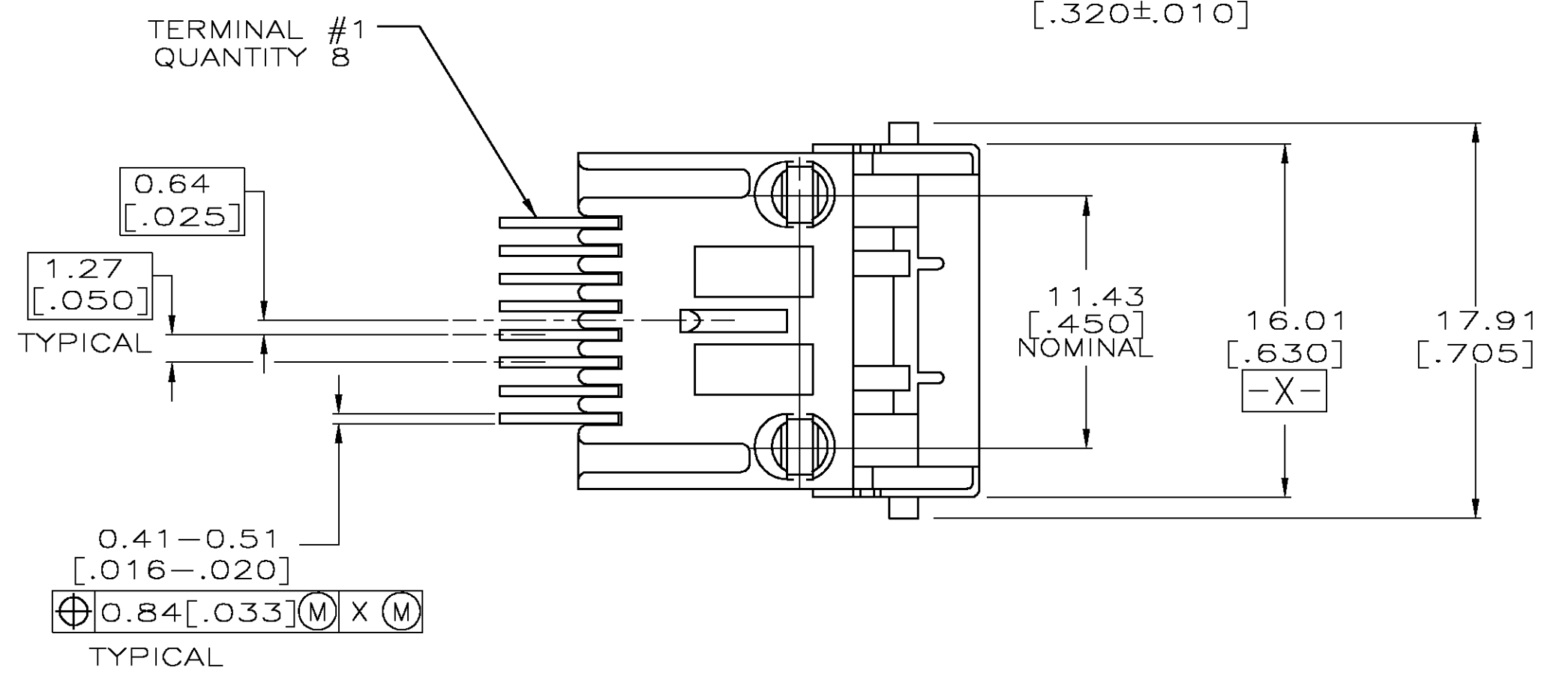
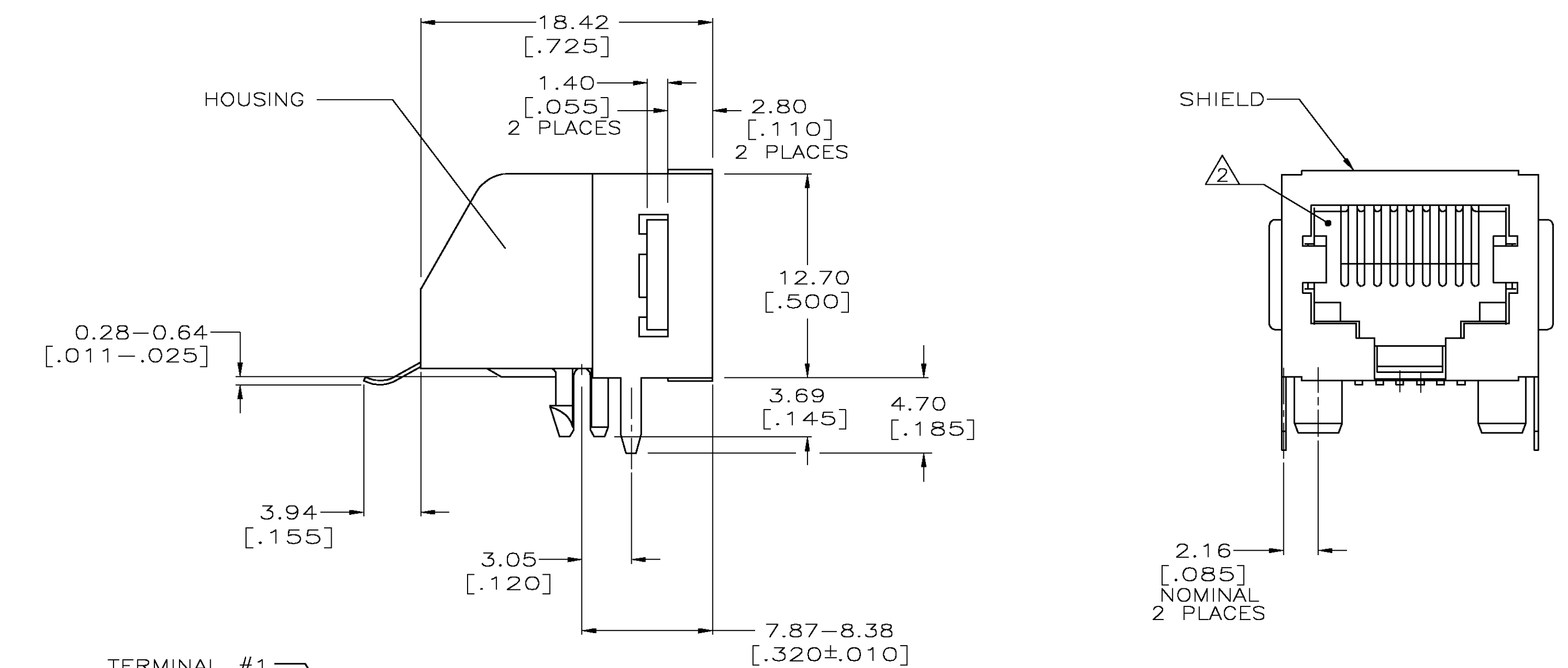


LOC		DIST		REVISIONS			DATE	APPD
GP	0	P	F	ZONE	LTR	DESCRIPTION	16DEC03	JB BK
				F		RLSD -2 ; EC 0511-0234-03		



- △ MATERIAL: HOUSING - HTN MOLDING COMPOUND, 94 VO, BLACK.
 TERMINAL- 0.36 [.014] THICK PHOS-BRONZE PLATE WITH 1.27µm [.000050] THICK HARD GOLD IN LOCALIZED GOLD PLATE AREA AND 3.81µm [.000150] THICK TIN-LEAD IN SOLDER AREA OVER 1.27µm [.000050] THICK NICKEL UNDERPLATE.
 SHIELD- 0.25 [.010] THICK COPPER ALLOY, PLATE WITH 2.03µm [.000080] THICK TIN-LEAD.
- △ CAVITY CONFORMS TO FCC RULES AND REGULATIONS, PART 68, SUBPART F.
- 3. DIMENSIONS ARE MAXIMUM UNLESS OTHERWISE SPECIFIED.
- 4. SNAP-IN RETENTION FEATURE ACCOMMODATES 1.44-1.71 [.062±.005] THICK PRINTED CIRCUIT BOARD.
- △ PACKAGING TAPE AND REEL: (PER EIA 481 SPECIFICATION)
 TAPE: 44 [1.73] WIDE
 POCKET DEPTH: 17.65 [.695]
 POCKET PITCH: 32 [1.26]
 CLEAR PSA TAPE TRAILER 160 [6.30] MIN LENGTH
 PLASTIC REEL DIA. 330 [13.0]
 PIECES PER REEL: 100

DO NOT SCALE PRINT. UNLESS SPECIFIED DIMENSIONS IN mm [INCHES] TOLERANCES ON :		DR 7-15-93 B. SIMPSON		AMP Incorporated Harrisburg, PA 17105-3608	
2 PLC DEC ± -		CHK 7-23-93 C. WHITT		NAME	
3 PLC DEC ± -		APPD 7-28-93 J. TONEY		MODULAR JACK ASSEMBLY, 8 POSITION, SHIELDED, LOW PROFILE, PRINTED CIRCUIT BOARD GROUND AND PANEL STOPS	
ANGLES ± -		APPD 7-28-93 H. MCGRATH		PRODUCT SPEC	
MATERIAL		108-1163		SIZE	
FINISH		APPLICATION SPEC 114-6040		CAGE CODE	
				DRAWING NO	
				D 00779 ©= 558178	
		WEIGHT -		SCALE 4:1	
				SHEET 10F 1	

THIS DRAWING IS A CONTROLLED DOCUMENT FOR AMP INCORPORATED. IT IS SUBJECT TO CHANGE AND THE CONTROLLING ENGINEERING ORGANIZATION SHOULD BE CONTACTED FOR THE LATEST REVISION.